

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicants:** Colgan, et al.

**Examiner:** Mitchell, James M.

**Serial No.:** 10/789,500

**Group:** Art Unit 2813

**Filed:** February 27, 2004

**Docket:** YOR920030527US1 (8728-665)

**For:        APPARATUS AND METHODS FOR COOLING**

**SEMICONDUCTOR INTEGRATED CIRCUIT PACKAGE STRUCTURES**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313

**SUPPLEMENTAL AMENDMENT**

This is a Supplemental Amendment to the Amendment filed on 12 April 2007 in response to the Office Action mailed on January 12, 2007. Please amend the claims as follows: